

此为证书 CN22/00003180 译本

SGS

下述组织

江苏长电科技股份有限公司
长电科技（滁州）有限公司
长电科技（宿迁）有限公司
星科金朋半导体（江阴）有限公司
江阴长电先进封装有限公司

中国江苏省江阴市滨江中路 275 号

的管理体系已经过审核，并被证明符合下述要求

ISO 22301:2019

所涉及的活动范围覆盖

业务连续性管理体系覆盖江阴、滁州、宿迁厂区：
半导体元件封装的设计及半导体元件的封装和测试；
半导体芯片凸块封装及 3D 封装测试。

该证书的有效期自 2022 年 09 月 13 日 至 2025 年 09 月 12 日 并须经过符合要求的监督审核保持有效

版本号 1. 初始注册日期 2022 年 09 月 13 日

在此范围内出具了多张证书，主证书编号为 CN22/00003180

在其它场所实施的认证活动在后续页面上列出

Jonathan M. Hall

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Jonathan Hall
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ISO 22301:2019

版本号 1
场所
江苏长电科技股份有限公司 中国江苏省江阴市滨江中路 275 号 业务连续性管理体系覆盖江阴、滁州、宿迁厂区： 半导体元件封装的设计及半导体元件的封装和测试； 半导体芯片凸块封装及 3D 封装测试。
江苏长电科技股份有限公司 中国江苏省江阴市澄江镇长山路 78 号 D3 楼 半导体元件封装的设计及半导体元件的封装和测试。
江苏长电科技股份有限公司 中国江苏省江阴市滨江中路 275 号 D3-1 楼 半导体元件封装的设计及半导体元件的封装和测试。
长电科技（滁州）有限公司 中国安徽省滁州市世纪大道 999 号 半导体元件封装的设计及半导体元件的封装和测试。
长电科技（宿迁）有限公司 中国江苏省宿迁市苏宿工业园区普陀山大道 5 号 半导体元件封装的设计及半导体元件的封装和测试。



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星科金朋半导体（江阴）有限公司 中国江苏省江阴市澄江镇长山路 78 号 JSCC-1 楼
半导体元件封装的设计及半导体元件的封装和测试。
江阴长电先进封装有限公司 中国江苏省江阴市澄江镇长山路 78 号 JCAP B2&B2B 楼
半导体芯片凸块封装及 3D 封装测试。
江阴长电先进封装有限公司 中国江苏省江阴市滨江中路 275 号 JCAP B1 楼
半导体芯片凸块封装及 3D 封装测试。



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Certificate CN22/00003180

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The management system of

JCET Group Co., Ltd.

JCET Semiconductor (Chuzhou) Co., Ltd.

JCET Semiconductor (Suqian) Co., Ltd.

STATS ChipPAC Semiconductor (Jiangyin) Co., Ltd.

JCET Advanced Packaging Co., Ltd.

No.275, Binjiang Middle Road, Jiangyin City, Jiangsu Province, P.R.China

has been assessed and certified as meeting the requirements of

ISO 22301:2019

For the following activities

The business continuity management system covers plants in Jiangyin, Chuzhou, Suqian:

Package design and assembly and testing of semiconductor devices;

Wafer Bumping and Wafer Level Chip Scale Packages / 3D packages with Probing.

This certificate is valid from 13 September 2022 until 12 September 2025 and remains valid subject to satisfactory surveillance audits.

Issue 1. Certified since 13 September 2022

Multiple certificates have been issued for this scope, the main certificate is numbered CN22/00003180

Certified activities performed by additional sites are listed on subsequent pages.

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ISO 22301:2019

Issue 1
Sites JCET Group Co., Ltd. No.275, Binjiang Middle Road, Jiangyin City, Jiangsu Province, P.R.China The business continuity management system covers plants in Jiangyin, Chuzhou, Suqian: Package design and assembly and testing of semiconductor devices; Wafer Bumping and Wafer Level Chip Scale Packages / 3D packages with Probing.
JCET Group Co., Ltd. Building D3, No.78, Changshan Road, Chengjiang Town, Jiangyin City, Jiangsu Province, P.R.China Package design and assembly and testing of semiconductor devices.
JCET Group Co., Ltd. Building D3-1, No.275, Binjiang Middle Road, Jiangyin City, Jiangsu Province, P.R.China Package design and assembly and testing of semiconductor devices.
JCET Semiconductor (Chuzhou) Co., Ltd. No.999, Shiji Road, Chuzhou City, Anhui Province, P.R.China Package design and assembly and testing of semiconductor devices.
JCET Semiconductor (Suqian) Co., Ltd. No.5, Putuoshan Road, Susu Industrial Park, Suqian City, Jiangsu Province, P.R.China Package design and assembly and testing of semiconductor devices.



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STATS ChipPAC Semiconductor (Jiangyin) Co., Ltd. Building JSCC-1, No.78, Changshan Road, Chengjiang Town, Jiangyin City, Jiangsu Province, P.R.China
Package design and assembly and testing of semiconductor devices.
JCET Advanced Packaging Co., Ltd Building JCAP B2&B2B, No.78, Changshan Road, Chengjiang Town, Jiangyin City, Jiangsu Province, P.R.China
Wafer Bumping and Wafer Level Chip Scale Packages / 3D packages with Probing
JCET Advanced Packaging Co., Ltd. Building JCAP B1, No.275, Binjiang Middle Road, Jiangyin City, Jiangsu Province, P.R.China
Wafer Bumping and Wafer Level Chip Scale Packages / 3D packages with Probing.



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Certificate CN22/00003180.01



JCET Group Co., Ltd.

No.275, Binjiang Middle Road, Jiangyin City, Jiangsu Province, P.R.China

Has been assessed under the management system of the certified organisation defined in the main certificate CN22/00003180 as meeting the requirements of

ISO 22301:2019

For the following activities

The business continuity management system covers plants in Jiangyin, Chuzhou, Suqian:
Package design and assembly and testing of semiconductor devices;
Wafer Bumping and Wafer Level Chip Scale Packages / 3D packages with Probing.

This certificate is valid from 13 September 2022 until 12 September 2025 and remains valid subject to satisfactory surveillance audits.

Issue 1.

The validity of this certificate depends on the validity of the main certificate.

Authorised by
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此为证书 CN22/00003180.01 译本

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江苏长电科技股份有限公司

中国江苏省江阴市滨江中路 275 号

依据主证书 CN22/00003180 中规定的管理体系已经过审核，并被证明符合下述要求

ISO 22301:2019

所涉及的活动范围覆盖

业务连续性管理体系覆盖江阴、滁州、宿迁厂区：

半导体元件封装的设计及半导体元件的封装和测试；

半导体芯片凸块封装及 3D 封装测试。

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江苏长电科技股份有限公司

中国江苏省江阴市澄江镇长山路 78 号 D3 楼

依据主证书 CN22/00003180 中规定的管理体系已经过审核，并被证明符合下述要求

ISO 22301:2019

所涉及的活动范围覆盖

半导体元件封装的设计及半导体元件的封装和测试。

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Certificate CN22/00003180.02

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JCET Group Co., Ltd.

Building D3, No.78, Changshan Road, Chengjiang Town, Jiangyin City, Jiangsu Province, P.R.China

Has been assessed under the management system of the certified organisation defined in the main certificate CN22/00003180 as meeting the requirements of

ISO 22301:2019

For the following activities

Package design and assembly and testing of semiconductor devices.

This certificate is valid from 13 September 2022 until 12 September 2025 and remains valid subject to satisfactory surveillance audits.

Issue 1.

The validity of this certificate depends on the validity of the main certificate.

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Global Head - Certification Services

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中国江苏省江阴市滨江中路 275 号 D3-1 楼

依据主证书 CN22/00003180 中规定的管理体系已经过审核，并被证明符合下述要求

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ISO 22301:2019

For the following activities

Package design and assembly and testing of semiconductor devices.

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JCET Semiconductor (Chuzhou) Co., Ltd.

No.999, Shiji Road, Chuzhou City, Anhui Province, P.R.China

Has been assessed under the management system of the certified organisation defined in the main certificate CN22/00003180 as meeting the requirements of

ISO 22301:2019

For the following activities

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Has been assessed under the management system of the certified organisation defined in the main certificate CN22/00003180 as meeting the requirements of

ISO 22301:2019

For the following activities

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中国江苏省宿迁市苏宿工业园区普陀山大道 5 号

依据主证书 CN22/00003180 中规定的管理体系已经过审核，并被证明符合下述要求

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所涉及的活动范围覆盖

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Certificate CN22/00003180.06

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STATS ChipPAC Semiconductor (Jiangyin) Co., Ltd.

Building JSCC-1, No.78, Changshan Road, Chengjiang Town, Jiangyin City, Jiangsu Province, P.R.China

Has been assessed under the management system of the certified organisation defined in the main certificate CN22/00003180 as meeting the requirements of

ISO 22301:2019

For the following activities

Package design and assembly and testing of semiconductor devices.

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星科金朋半导体（江阴）有限公司

中国江苏省江阴市澄江镇长山路 78 号 JSCC-1 楼

依据主证书 CN22/00003180 中规定的管理体系已经过审核，并被证明符合下述要求

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所涉及的活动范围覆盖

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